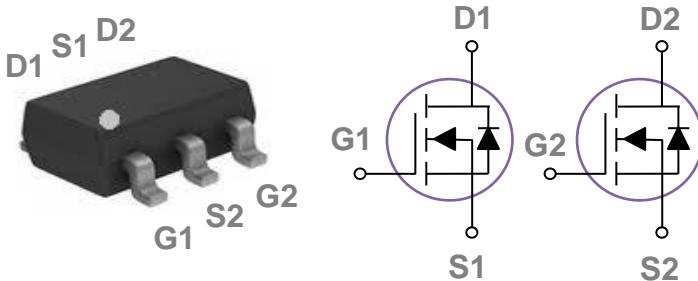


General Description

These dual N Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOT23-6 Dual Pin Configuration



BVDSS	RDS(ON)	ID
20V	60mΩ	3.6A

Features

- 20V, 3.6A, $RDS(ON) = 60m\Omega @ VGS = 4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for 1.8V Gate Drive Applications

Applications

- Notebook
- Load Switch
- Hand-Held Instruments

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 10	V
I_D	Drain Current – Continuous ($T_A=25^\circ C$)	3.6	A
	Drain Current – Continuous ($T_A=70^\circ C$)	2.9	A
I_{DM}	Drain Current – Pulsed ¹	14.4	A
P_D	Power Dissipation ($T_A=25^\circ C$)	1.25	W
	Power Dissipation – Derate above $25^\circ C$	0.01	W/ $^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	100	$^\circ C/W$

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=250\mu\text{A}$	20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $\text{I}_D=1\text{mA}$	---	0.02	---	$^\circ\text{C}$
I_{DS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=20\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$\text{V}_{\text{DS}}=16\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	10	μA
I_{GS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 10\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$\text{V}_{\text{GS}}=4.5\text{V}$, $\text{I}_D=3\text{A}$	---	50	60	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=2.5\text{V}$, $\text{I}_D=2\text{A}$	---	60	80	
		$\text{V}_{\text{GS}}=1.8\text{V}$, $\text{I}_D=1\text{A}$	---	85	110	
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$, $\text{I}_D = 250\mu\text{A}$	0.3	0.5	1	V
$\Delta \text{V}_{\text{GS(th)}}$	$\text{V}_{\text{GS(th)}}$ Temperature Coefficient		---	2	---	$\text{mV}/^\circ\text{C}$
gfs	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}$, $\text{I}_S=2\text{A}$	---	4.4	---	S

Dynamic and switching Characteristics

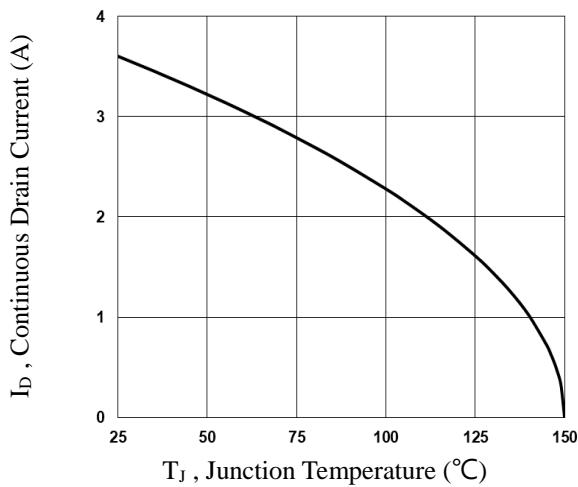
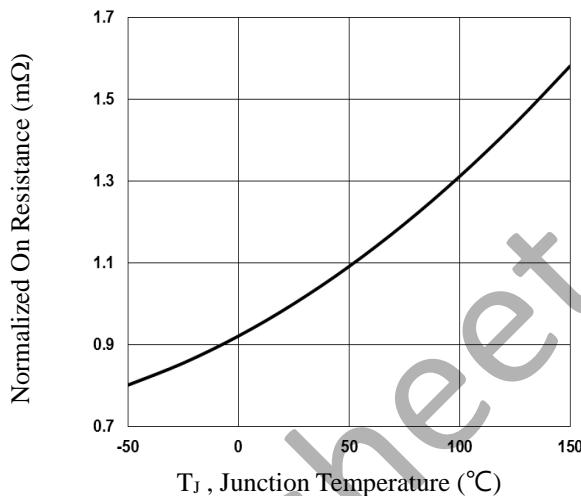
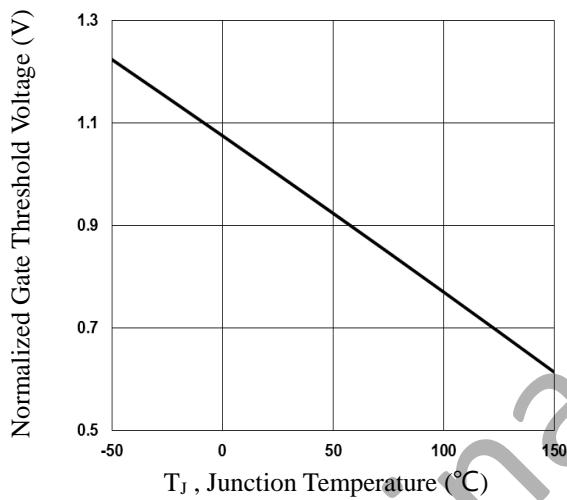
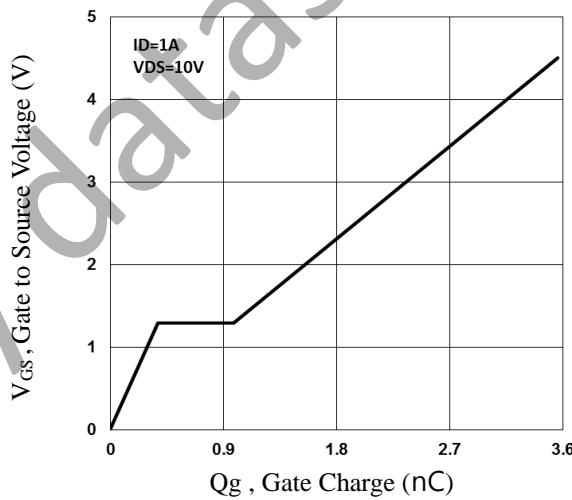
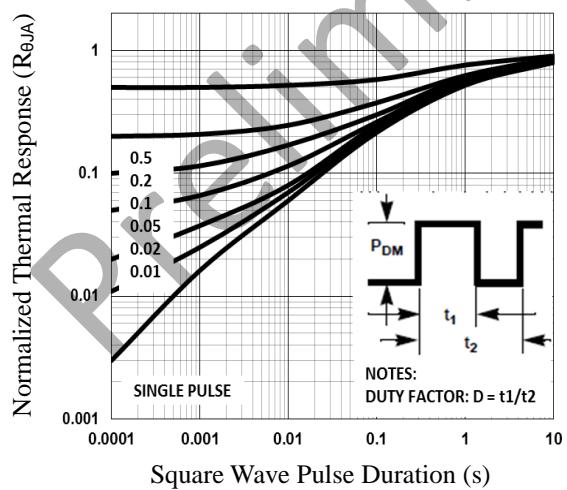
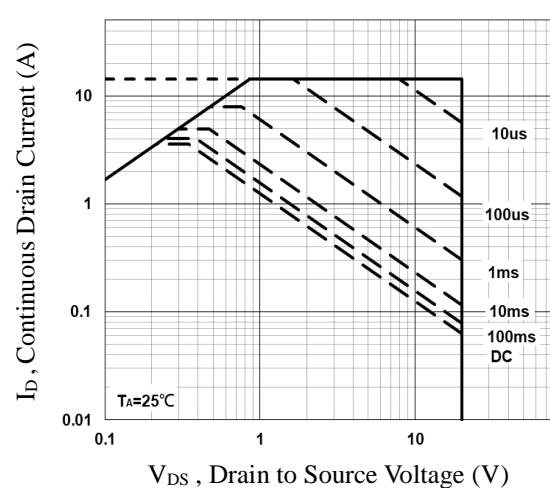
Q_g	Total Gate Charge ^{2, 3}	$\text{V}_{\text{DS}}=10\text{V}$, $\text{V}_{\text{GS}}=4.5\text{V}$, $\text{I}_D=1\text{A}$	---	3.6	7.2	nC
Q_{gs}	Gate-Source Charge ^{2, 3}		---	0.38	0.76	
Q_{gd}	Gate-Drain Charge ^{2, 3}		---	0.6	1.2	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time ^{2, 3}	$\text{V}_{\text{DD}}=10\text{V}$, $\text{V}_{\text{GS}}=4.5\text{V}$, $\text{R}_G=25\Omega$ $\text{I}_D=1\text{A}$	---	1.8	5	nS
T_r	Rise Time ^{2, 3}		---	5.6	12	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time ^{2, 3}		---	11.3	24	
T_f	Fall Time ^{2, 3}		---	3.2	7	
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=15\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $\text{F}=1\text{MHz}$	---	180	360	pF
C_{oss}	Output Capacitance		---	32	64	
C_{rss}	Reverse Transfer Capacitance		---	26	52	

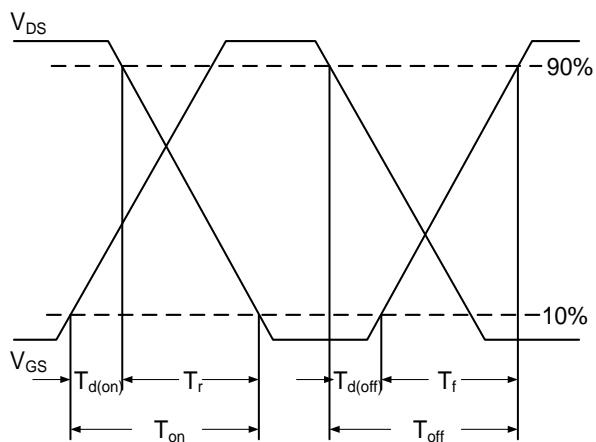
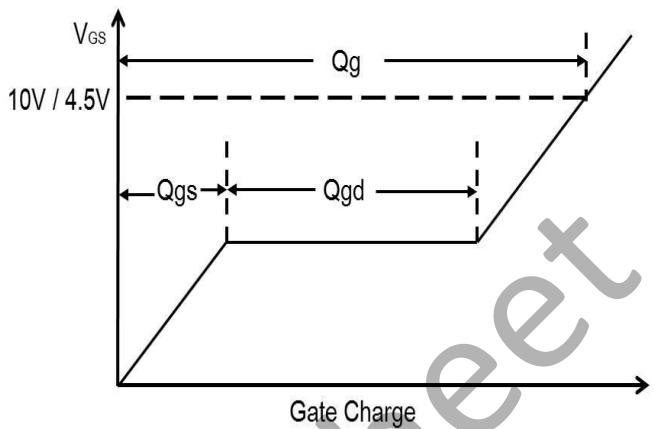
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$\text{V}_G=\text{V}_D=0\text{V}$, Force Current	---	---	3.6	A
I_{SM}	Pulsed Source Current		---	---	7.2	A
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V

Note :

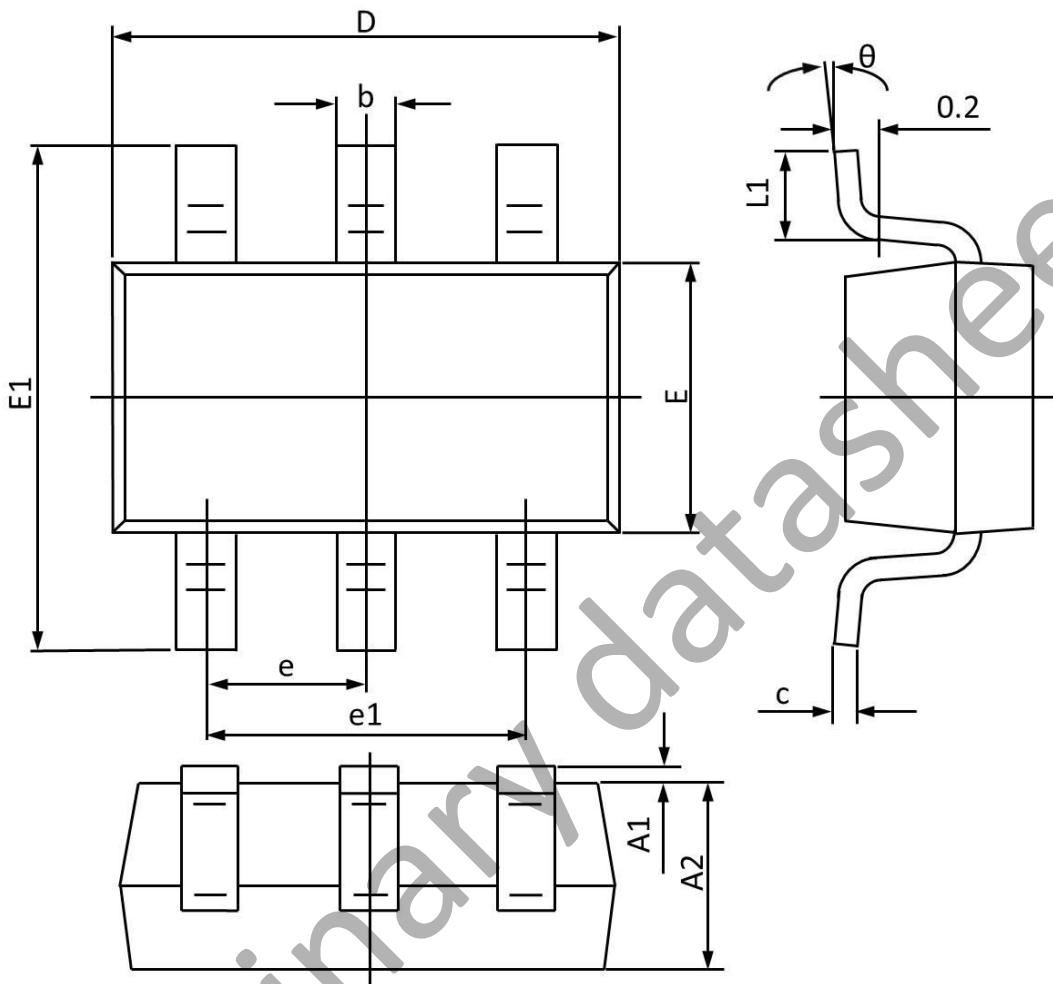
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. T_J

Fig.2 Normalized $R_{DS(on)}$ vs. T_J

Fig.3 Normalized V_{th} vs. T_J

Fig.4 Gate Charge Waveform

Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

Preliminary datasheet

SOT23-6 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A1	0.000	0.100	0.000	0.004
A2	1.000	1.200	0.040	0.047
b	0.300	0.500	0.012	0.019
c	0.047	0.207	0.002	0.008
D	2.800	3.000	0.110	0.118
E	1.500	1.800	0.059	0.070
E1	2.600	3.000	0.103	0.118
e	0.950 TYP		0.037 TYP	
e1	1.900 TYP		0.075 TYP	
L1	0.250	0.550	0.010	0.021
θ	0°	8°	0°	8°